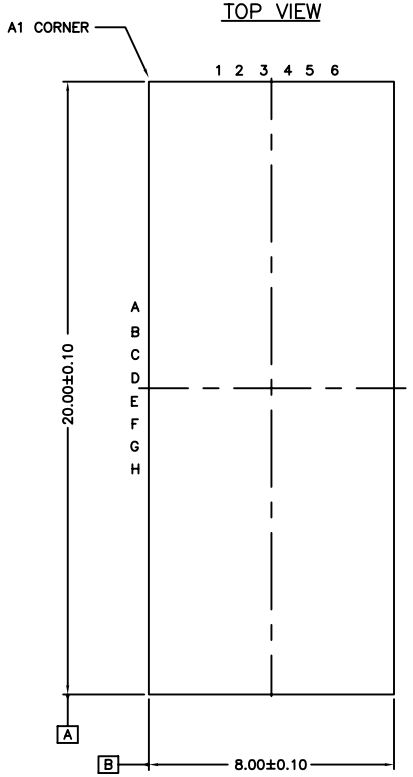
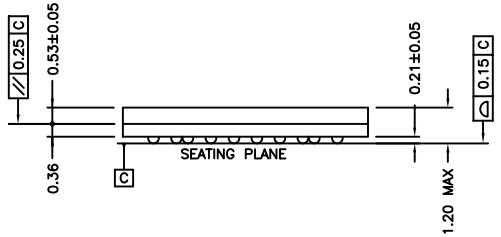
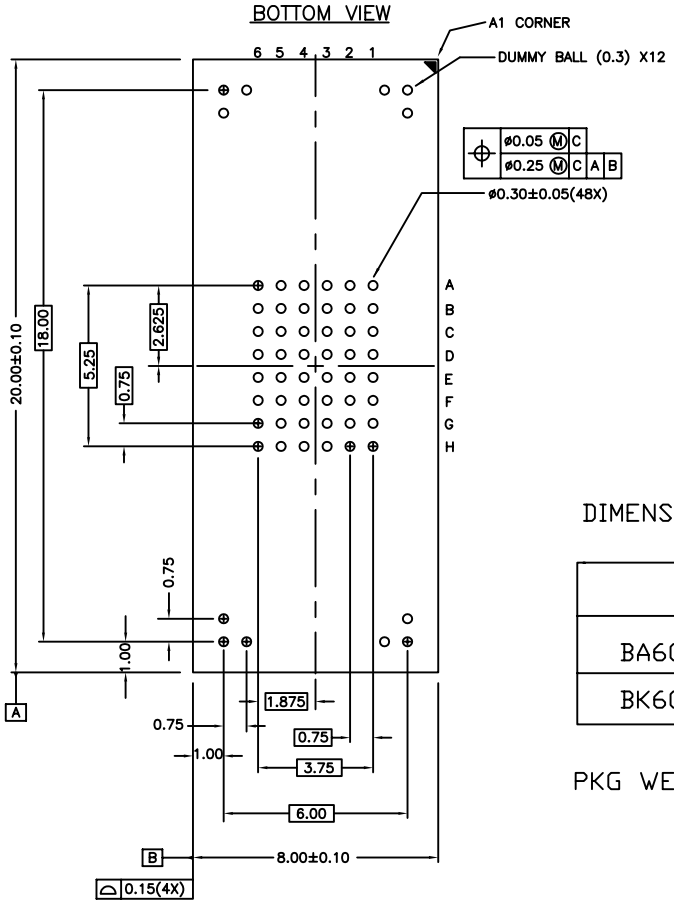
REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	–	**	113971	NEW RELEASE	03/12/02	N/A
1	–	*A	118432	CHG. PKG. BODY TOLERANCE/ADD MOLD CAP & SUBSTRATE DIM./ CHG. LEAD COPLANARITY	08/29/02	N/A
1	–	*B	209983	UPDATE DUMMY PAD TO DUMMY BALL/ CHANGE TITLE	03/10/04	N/A
1	–	*C	351732	ADD DIM./ ADD BK PART #	04/19/05	N/A
1	–	*D	400517	A) CHANGE TITLE TO 60FBGA (8X20X1.2mm) PACKAGE OUTLINE B) CHANGE PART # TO BA60A / BK60A	10/06/05	N/A
1	–	*E	2811684	Change Template and title from 60 FBGA (8x20x1.2MM) PACKAGE OUTLINE to PACKAGE OUTLINE, 60L FBGA 8X20X1.2 MM BA60A/BK60A.	11/20/09	QAD
1	–	*F	3738857	Sunset Review, Changed Package Weight: 0.30 gms to Package Weight: Refer to PMDD Spec.	09/10/12	QAD

TOP VIEW





BOTTOM VIEW



DIMENSIONS IN MM

PART #	
BA60A	STANDARD PKG.
BK60A	LEAD FREE PKG.

PKG WEIGHT: REFER TO PMDD SPEC.

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UNLESS OTHERWISE SPECIFIED
ALL DIMENSIONS ARE IN MILLIMETERS
STANDARD TOLERANCES ON:
DECIMALS .XX ± 0.05 .XXX ± .XXXX +
ANGLES ± 1°

MATERIAL N/A
FINISH N/A

DESIGNED BY	JVP	DATE 04/19/05
DRAWN BY	ROWI	DATE 09/10/12
CHECKED BY	QAD	DATE 09/10/12
APPROVED BY	EDCA	DATE 09/10/12
APPROVED BY	PRC	DATE 09/10/12
APPROVED BY	NA	DATE NA

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TITLE: PACKAGE OUTLINE, 60L FBGA 8X20X1.2 MM BA60A/BK60A

SIZE	PART NO.	DWG NO	REV
A	BA60A/BK60A	51-85162	*F

SCALED TO FIT | N/A | SHEET 1 OF 1